Octal 3-State Noninverting Buffer/Line Driver/ Line Receiver

High–Performance Silicon–Gate CMOS

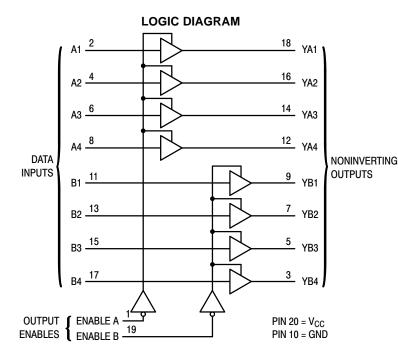
The MC74HC244A is identical in pinout to the LS244. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LSTTL outputs.

This octal noninverting buffer/line driver/line receiver is designed to be used with 3-state memory address drivers, clock drivers, and other bus-oriented systems. The device has noninverting outputs and two active-low output enables.

The HC244A is similar in function to the HC240A.

Features

- Output Drive Capability: 15 LSTTL Loads
- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2.0 to 6.0 V
- Low Input Current: 1 μA
- High Noise Immunity Characteristic of CMOS Devices
- In Compliance with the Requirements Defined by JEDEC Standard No. 7 A
- Chip Complexity: 136 FETs or 34 Equivalent Gates
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant





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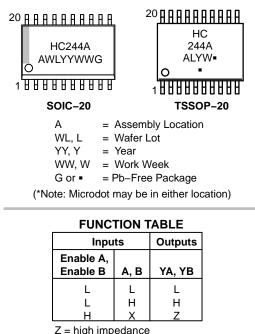
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PIN ASSIGNMENT

| - | | | • |
|----------|----|----|-------------------|
| ENABLE A | 1● | 20 | □ v _{cc} |
| A1 [| 2 | 19 | ENABLE B |
| ΥВ4 [| 3 | 18 | D YA1 |
| A2 [| 4 | 17 | р в4 |
| ҮВЗ 🛛 | 5 | 16 | D YA2 |
| A3 [| 6 | 15 | 🛛 ВЗ |
| YB2 [| 7 | 14 | 🛛 ҮАЗ |
| A4 [| 8 | 13 | р в2 |
| YB1 [| 9 | 12 | D YA4 |
| GND [| 10 | 11 | <u>р</u> В1 |

MARKING DIAGRAMS



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
|------------------|--|-------------------------------|------|
| V _{CC} | DC Supply Voltage (Referenced to GND) | -0.5 to +7.0 | V |
| V _{in} | DC Input Voltage (Referenced to GND) | –0.5 to V _{CC} + 0.5 | V |
| Vout | DC Output Voltage (Referenced to GND) | –0.5 to V _{CC} + 0.5 | V |
| l _{in} | DC Input Current, per Pin | ±20 | mA |
| l _{out} | DC Output Current, per Pin | ±35 | mA |
| I _{CC} | DC Supply Current, V_{CC} and GND Pins | ±75 | mA |
| I _{IK} | Input Clamp Current ($V_I < 0$ or $V_I > V_{CC}$) | ±20 | mA |
| I _{OK} | Output Clamp Current ($V_O < 0$ or $V_O > V_{CC}$) | ±20 | mA |
| PD | Power Dissipation in Still Air, SOIC Package† TSSOP Package† | 500 450 | mW |
| T _{stg} | Storage Temperature | -65 to +150 | °C |
| ΤL | Lead Temperature, 1 mm from Case for 10 Seconds (SOIC, SSOP or TSSOP Package) | 260 | °C |

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high–impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range GND \leq (V_{in} or V_{out}) \leq V_{CC}.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

†Derating: SOIC Package: -7 mW/°C from 65° to 125°C

TSSOP Package: -6.1 mW/°C from 65° to 125°C

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | | Min | Max | Unit |
|------------------------------------|--|-------------------------------|-------------|--------------------|------|
| V _{CC} | DC Supply Voltage (Referenced to GND) | | 2.0 | 6.0 | V |
| V _{in} , V _{out} | DC Input Voltage, Output Voltage (Referenced to GND) | | 0 | V _{CC} | V |
| T _A | Operating Temperature, All Package Types | | -55 | +125 | °C |
| t _r , t _f | (Figure 1) V _{CC} | = 2.0 V = 4.5 V = 6.0 V | 0 0 0 | 1000 500 400 | ns |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

MC74HC244A

| | | | | Gu | aranteed Li | mit | |
|-----------------|---|--|--------------------------|---------------------------|---------------------------|---------------------------|------|
| Symbol | Parameter | Test Conditions | v _{cc} v | –55 to 25°C | ≤ 85°C | ≤ 125°C | Unit |
| V _{IH} | Minimum High-Level Input Voltage | $\begin{aligned} V_{out} = V_{CC} - 0.1 V \\ I_{out} \le 20 \ \mu A \end{aligned} \label{eq:vout}$ | 2.0 3.0 4.5 6.0 | 1.5 2.1 3.15 4.2 | 1.5 2.1 3.15 4.2 | 1.5 2.1 3.15 4.2 | V |
| V _{IL} | Maximum Low–Level Input Voltage | $\begin{array}{l} V_{out} = 0.1 \ V \\ I_{out} \leq 20 \ \mu A \end{array}$ | 2.0 3.0 4.5 6.0 | 0.5 0.9 1.35 1.8 | 0.5 0.9 1.35 1.8 | 0.5 0.9 1.35 1.8 | V |
| V _{OH} | Minimum High–Level Output Voltage | $V_{in} = V_{IH}$ $ I_{out} \le 20 \ \mu A$ | 2.0 4.5 6.0 | 1.9 4.4 5.9 | 1.9 4.4 5.9 | 1.9 4.4 5.9 | V |
| | | $ \begin{aligned} V_{in} = V_{IH} & I_{out} \leq 2.4 \text{ mA} \\ I_{out} \leq 6.0 \text{ mA} \\ I_{out} \leq 7.8 \text{ mA} \end{aligned} $ | 3.0 4.5 6.0 | 2.48 3.98 5.48 | 2.34 3.84 5.34 | 2.2 3.7 5.2 | |
| V _{OL} | Maximum Low–Level Output Voltage | $ \begin{array}{l} V_{in} = V_{IL} \\ I_{out} \leq 20 \ \mu A \end{array} $ | 2.0 4.5 6.0 | 0.1 0.1 0.1 | 0.1 0.1 0.1 | 0.1 0.1 0.1 | V |
| | | | 3.0 4.5 6.0 | 0.26 0.26 0.26 | 0.33 0.33 0.33 | 0.4 0.4 0.4 | |
| l _{in} | Maximum Input Leakage Current | V _{in} = V _{CC} or GND | 6.0 | ±0.1 | ±1.0 | ±1.0 | μΑ |
| I _{OZ} | Maximum Three-State Leakage Current | $\begin{array}{l} \text{Output in High-Impedance State} \\ \text{V}_{in} = \text{V}_{IL} \text{ or V}_{IH} \\ \text{V}_{out} = \text{V}_{CC} \text{ or GND} \end{array}$ | 6.0 | ±0.5 | ±5.0 | ±10 | μΑ |
| ICC | Maximum Quiescent Supply Cur- rent (per Package) | $V_{in} = V_{CC} \text{ or } GND$ $I_{out} = 0 \ \mu A$ | 6.0 | 4.0 | 40 | 160 | μΑ |

DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

AC ELECTRICAL CHARACTERISTICS (C_L = 50 pF, Input $t_r = t_f = 6 \text{ ns}$)

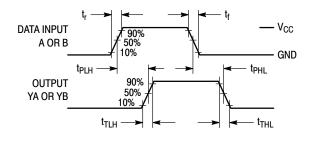
| | | | Guaranteed Limit | | | |
|--|--|--------------------------|---|-----------------------|-----------------------|------|
| Symbol | Parameter | V _{CC} V | –55 to 25°C | ≤85°C | ≤125°C | Unit |
| t _{PLH} , t _{PHL} | Maximum Propagation Delay, A to YA or B to YB (Figures 1 and 3) | 2.0 3.0 4.5 6.0 | 96 50 18 15 | 115 60 23 20 | 135 70 27 23 | ns |
| t _{PLZ} , t _{PHZ} | Maximum Propagation Delay, Output Enable to YA or YB (Figures 2 and 4) | 2.0 3.0 4.5 6.0 | 110 60 22 19 | 140 70 28 24 | 165 80 33 28 | ns |
| t _{PZL} , t _{PZH} | Maximum Propagation Delay, Output Enable to YA or YB (Figures 2 and 4) | 2.0 3.0 4.5 6.0 | 110 60 22 19 | 140 70 28 24 | 165 80 33 28 | ns |
| t _{TLH} , t _{THL} | Maximum Output Transition Time, Any Output (Figures 1 and 3) | 2.0 3.0 4.5 6.0 | 60 23 12 10 | 75 27 15 13 | 90 32 18 15 | ns |
| C _{in} | Maximum Input Capacitance | - | 10 | 10 | 10 | pF |
| C _{out} | Maximum Three–State Output Capacitance (Output in High–Impedance State) | _ | 15 | 15 | 15 | pF |
| | | | Typical @ 25°C, V _{CC} = 5.0 V | | _C = 5.0 V | |
| C _{PD} | Power Dissipation Capacitance (Per Buffer)* | | | 34 | | pF |

| | | Typical @ 25°C, V _{CC} = 5.0 V | |
|-----------------|---|---|----|
| C _{PD} | Power Dissipation Capacitance (Per Buffer)* | 34 | pF |
| | | | |

* Used to determine the no-load dynamic power consumption: $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$.

MC74HC244A

SWITCHING WAVEFORMS



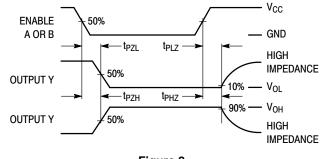
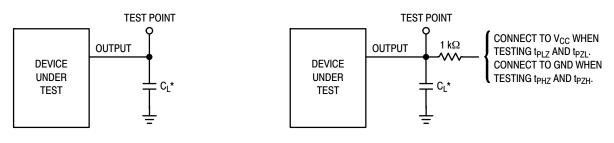


Figure 1.



TEST CIRCUITS



*Includes all probe and jig capacitance

Figure 3. Test Circuit

*Includes all probe and jig capacitance

Figure 4. Test Circuit

PIN DESCRIPTIONS

INPUTS

A1, A2, A3, A4, B1, B2, B3, B4

(Pins 2, 4, 6, 8, 11, 13, 15, 17)

Data input pins. Data on these pins appear in noninverted form on the corresponding Y outputs, when the outputs are enabled.

CONTROLS

Enable A, Enable B (Pins 1, 19)

Output enables (active-low). When a low level is applied to these pins, the outputs are enabled and the devices

function as noninverting buffers. When a high level is applied, the outputs assume the high impedance state.

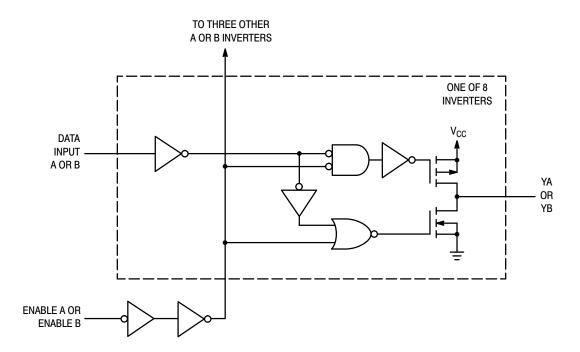
OUTPUTS

YA1, YA2, YA3, YA4, YB1, YB2, YB3, YB4 (Pins 18, 16, 14, 12, 9, 7, 5, 3)

Device outputs. Depending upon the state of the output–enable pins, these outputs are either noninverting outputs or high–impedance outputs.

MC74HC244A

LOGIC DETAIL



ORDERING INFORMATION

| Device | Package | Shipping [†] |
|-------------------|---------------------------|-----------------------|
| MC74HC244ADWG | SOIC-20 WIDE (Pb-Free) | 38 Units / Rail |
| MC74HC244ADWR2G | SOIC-20 WIDE (Pb-Free) | 1000 / Tape & Reel |
| MC74HC244ADTG | TSSOP-20 (Pb-Free) | 75 Units / Rail |
| MC74HC244ADTR2G | TSSOP-20 (Pb-Free) | 2500 / Tape & Reel |
| NLV74HC244ADWR2G* | SOIC-20 WIDE (Pb-Free) | 1000 / Tape & Reel |
| NLV74HC244ADTR2G* | TSSOP-20 (Pb-Free) | 2500 / Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q100 Qualified and PPAP

Capable

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